



## Product Change Notification - RMES-11XZBK215

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**Date:**

17 Feb 2020

**Product Category:**

Memory

**Affected CPNs:****Notification subject:**

CCB 4104 Initial Notice: Qualification of MTAI as a new assembly site for selected products available in 8L SOIJ (.208 in) package.

**Notification text:****PCN Status:**

Initial notification

**PCN Type:**

Manufacturing Change

**Microchip Parts Affected:**

Please open one of the files found in the Affected CPNs section above to see all listed items.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of MTAI as a new assembly site for selected products available in 8L SOIJ (.208 in) package.

**Pre-Change:**

Assembled at LPI assembly site using 8290 die attached material.

**Post Change:**

Assembled at MTAI assembly site using 8006NS die attached material.

**Pre and Post Change Summary:**

	Pre-Change	Post Change
Assembly Site	Lingsen Precision Industries, Taiwan. (LPI)	Microchip Technology Thailand (HQ) / MTAI
Wire material	Au	Au
Lead frame material	C194	C194
Die attach material	8290	8006NS
Molding compound material	G600	G600

**Impacts to Data Sheet:**

None

**Change Impact:**

None

**Reason for Change:**

To improve productivity by qualifying MTAI as a new assembly site.

**Change Implementation Status:**

In Progress

**Estimated Qualification Completion Date:**

February 2020

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and



a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts

**Time Table Summary:**

	February 2020				
Workweek	05	06	07	08	09
Initial PCN Issue Date				X	
Final PCN Issue Date					X
Qual Plan Availability					X

**Method to Identify Change:**

Traceability code

**Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

**Revision History:**

**February 17, 2020:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

**Terms and Conditions:**

If you wish to [receive Microchip PCNs via email](#) please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to [change your PCN profile, including opt out](#), please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected parts

SST25VF016B-50-4C-S2AF-DCQ  
SST25VF016B-50-4C-S2AF  
SST25VF016B-50-4C-S2AF-PP018  
SST25VF016B-50-4C-S2AF-PP022  
SST25VF016B-50-4C-S2AF-PP013  
SST25VF016B-50-4I-S2AF  
SST25VF016B-50-4I-S2AF-PP022  
SST25VF016B-50-4I-S2AF-DCA  
SST25VF016B-50-4I-S2AF-GYR  
SST25VF016B-50-4C-S2AF-DCQ-T  
SST25VF016B-50-4C-S2AF-T  
SST25VF016B-50-4C-S2AF-PP013-T  
SST25VF016B-50-4I-S2AF-T  
SST25VF016B-50-4I-S2AF-DCA-T  
SST25VF016B-50-4I-S2AF-GYR-T